

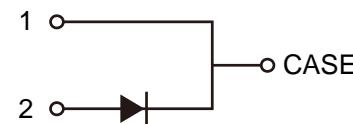
$V_{RRM}$  = 1200 V

$I_F (T_C=150^\circ\text{C})$  = 10 A

$Q_c$  = 52 nC

TO-252-2

CASE



## Features

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on  $V_F$
- Excellent surge current capability
- Low capacitive charge

## Benefits

- Essentially no switching losses
- System efficiency improvement over Si diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of heat sink requirements
- System cost savings due to smaller magnetics
- Reduced EMI

## Applications

- Switch mode power supplies (SMPS)
- Uninterruptible power supplies
- Motor drivers
- Power factor correction

## Package Pin Definitions

- Pin1- Cathode
- Pin2- Anode

## Package Parameters

Part Number	Marking	Package
B1D10120E	B1D10120E	TO-252-2



**Maximum Ratings (T<sub>c</sub>=25°C unless otherwise specified)**

Symbol	Parameter	Test conditions	Value	Unit
V <sub>RRM</sub>	Repetitive peak reverse voltage		1200	V
V <sub>RSM</sub>	Non-repetitive peak reverse voltage		1200	V
I <sub>F</sub>	Continuous forward current	T <sub>c</sub> =25°C T <sub>c</sub> =150°C	31 10	A
I <sub>FSM</sub>	Non-Repetitive forward surge current	T <sub>c</sub> =25°C , t <sub>p</sub> =10ms, Half Sine Wave	75	A
∫i <sup>2</sup> dt	i <sup>2</sup> t value	T <sub>c</sub> =25°C , t <sub>p</sub> =10ms	28.12	A <sup>2</sup> S
P <sub>tot</sub>	Power dissipation	T <sub>c</sub> =25°C T <sub>c</sub> =110°C	143 62	W
T <sub>j</sub>	Operating junction temperature		-55~175	°C
T <sub>stg</sub>	Storage temperature		-55~135	°C

**Thermal Characteristics**

Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
R <sub>th(jc)</sub>	Thermal resistance from junction to case		1.042		K/W

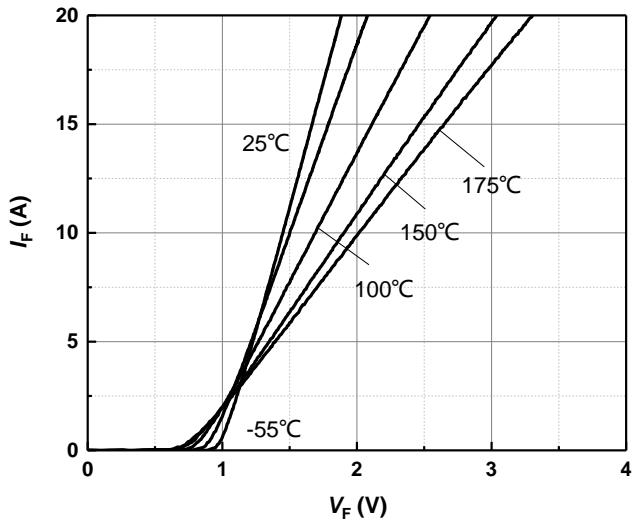
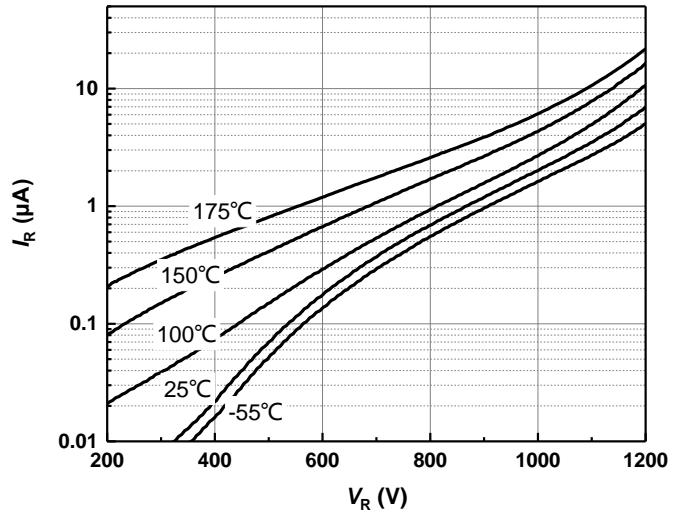
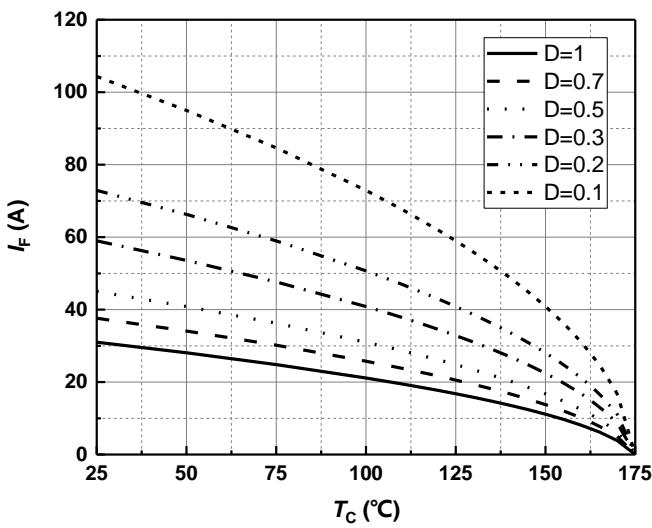
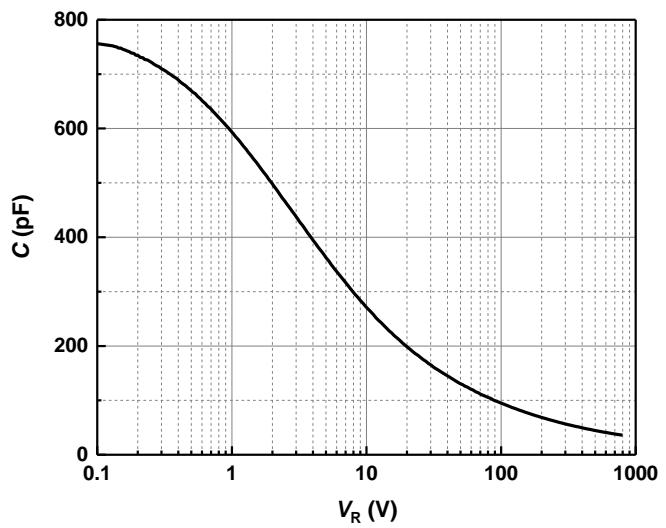
### Electrical Characteristics

#### Static Characteristics

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
$V_{DC}$	DC blocking voltage	$T_j=25^\circ C$	1200			V
$V_F$	Diode forward voltage	$I_F=10A T_j=25^\circ C$ $I_F=10A T_j=175^\circ C$		1.48 1.9		V
$I_R$	Reverse current	$V_R=1200V T_j=25^\circ C$ $V_R=1200V T_j=175^\circ C$		10 20		$\mu A$

#### AC Characteristics

<b>Symbol</b>	<b>Parameter</b>	<b>Test conditions</b>	<b>Value</b>			<b>Unit</b>
			<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	
$Q_c$	Total capacitive charge	$V_R=800V T_j=25^\circ C$ $Q_c = \int_0^{V_R} C(V)dV$		52		nC
C	Total capacitance	$V_R=1V f=1MHz$ $V_R=400V f=1MHz$ $V_R=800V f=1MHz$		591 49 36		pF
$E_c$	Capacitance stored energy	$V_R=800V$		14		$\mu J$

**Typical Performance**

**Figure 1. Typical forward characteristics**

**Figure 2. Typical reverse current as function of reverse voltage**

**Figure 3. Diode forward current as function of temperature, D=duty cycle**

**Figure 4. Typical capacitance as function of reverse voltage,  $C=f(V_R)$ ;  $T_j=25^\circ\text{C}$ ;  $f=1 \text{ MHz}$**

### Typical Performance

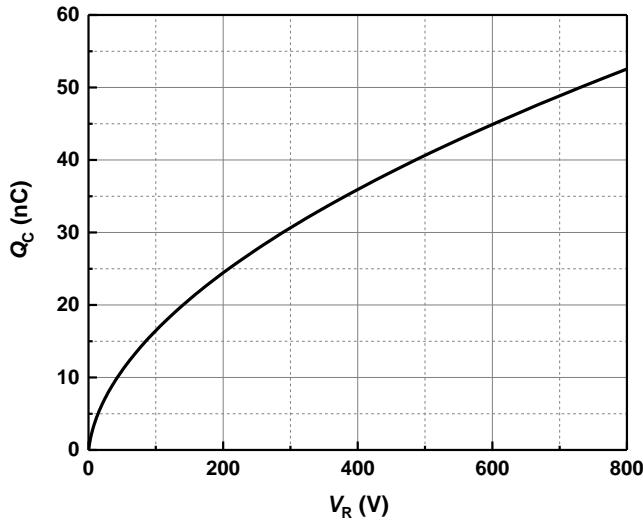


Figure 5. Typical reverse charge as function of reverse voltage

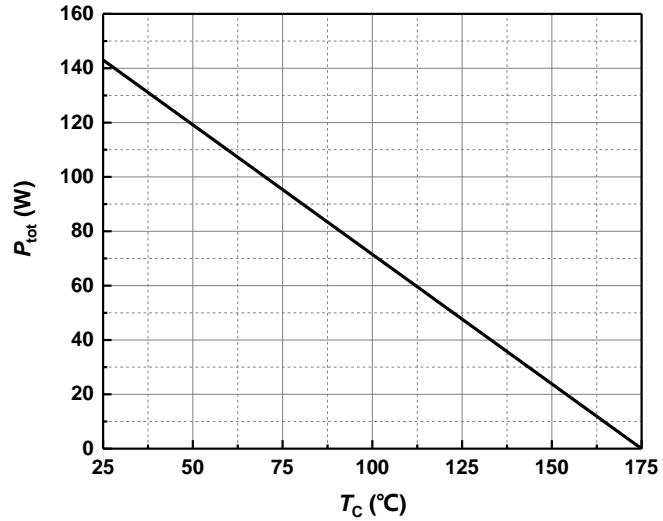


Figure 6. Power dissipation as function of case temperature

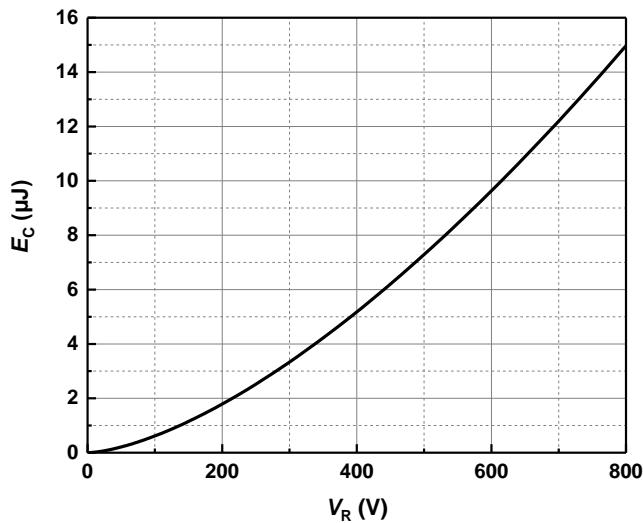


Figure 7. Capacitance stored energy

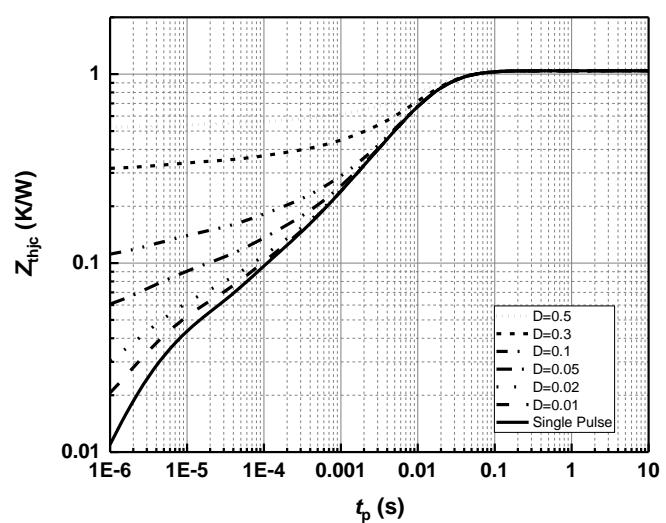
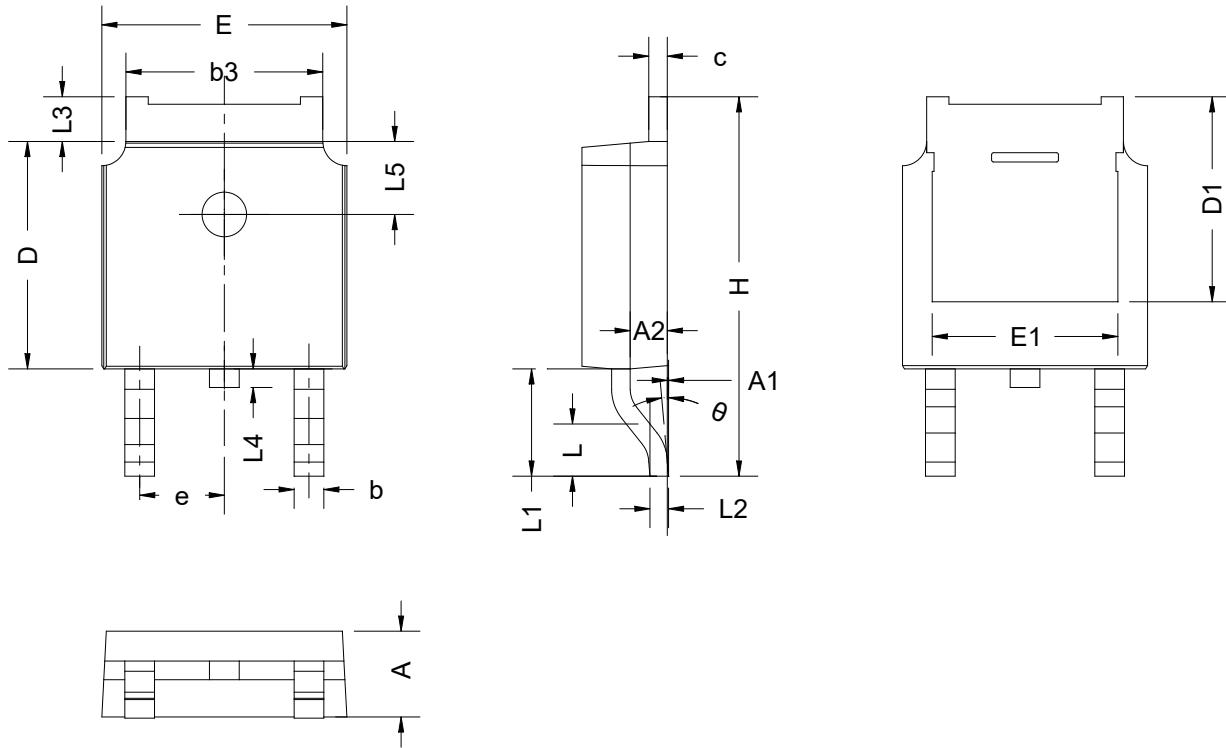


Figure 8. Max. transient thermal impedance,  $Z_{thjc} = f(t)$ , parameter:  $D = t/T$

## Package Dimensions



SYMBOL	mm		
	MIN	NOM	MAX
A	2.20	2.30	2.38
A1	0.00	-	0.20
A2	0.90	1.07	1.17
b	0.68	0.78	0.90
b3	5.13	5.33	5.46
c	0.43	0.53	0.61
D	5.98	6.10	6.22
D1	5.30 REF		
E	6.40	6.60	6.73
E1	4.63	-	-
e	2.286 BSC		
H	9.40	10.10	10.50
L	1.38	1.50	1.75
L1	2.90 REF		
L2	0.51 BSC		
L3	0.88	-	1.28
L4	0.50	-	1.00
L5	1.65	1.80	1.95
θ	0 °	-	8 °

## Revision History

Document Version	Date of Release	Description of Changes
Rev. 1.0	2020-07-06	Release of the datasheet.

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